

MOSFET

OptiMOS™ 6 Power-Transistor, 150 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

Product validation

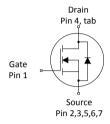
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

Parameter	Value	Unit
$V_{ m DS}$	150	V
R _{DS(on),max}	3.6	mΩ
I_{D}	190	А
$Q_{\rm oss}$	205	nC
Q_{G}	69	nC
Q _{rr} (500A/μs)	156	nC









Type / Ordering code	Package	Marking	Related links
IPF036N15NM6	PG-TO263-7	036N15N6	-

Public

OptiMOS™ 6 Power-Transistor, 150 V IPF036N15NM6



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OptiMOS™ 6 Power-Transistor, 150 V IPF036N15NM6



1 Maximum ratings

at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Darameter	Symbol	Values			Linit	Note / Took oon dition	
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition	
Continuous drain current ¹⁾	I _D	-	-	190 134 123 21	А	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	760	Α	T -25 °C	
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	84	А	T _C =25 °C	
Avalanche energy, single pulse	E _{AS}	-	-	484	mJ	$I_{\rm D}$ =53 A, $R_{\rm GS}$ =25 Ω	
Gate source voltage	V_{GS}	-20	-	20	V	-	
Power dissipation	P_{tot}	_	-	294 3.8	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾	
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$	-55	-	175	°C	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			I Imit	Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case	R_{thJC}	-	-	0.51	°C/W	
Thermal resistance, junction - ambient, 6 cm² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	$R_{ m thJA}$	-	-	62	°C/W	

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

²⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics

at $T_{\rm j}$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			I Imit	Note / Test condition
raiailletei	Syllibot	Min.	Тур.	Max.	Oilit	Note / Test condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.5	4.0	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 179 \mu \text{A}$
Zero gate voltage drain current	I_{DSS}	-	0.1 10	1 100	μΑ	$V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =120 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	-	3.0 3.3 3.6	3.4 3.6 4.3	mΩ	V_{GS} =15 V, I_{D} =84 A V_{GS} =10 V, I_{D} =84 A V_{GS} =8 V, I_{D} =42 A
Gate resistance	R_{G}	-	0.98	1.47	Ω	-
Transconductance	g_{fs}	70	140	_	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 84 \text{ A}$

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Input capacitance ⁶⁾	C _{iss}	-	4900	6400	pF	
Output capacitance ⁶⁾	C _{oss}	-	1500	2000	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ⁶⁾	C _{rss}	-	19	33	pF	
Turn-on delay time	$t_{d(on)}$	-	15	-	ns	
Rise time	t _r	-	9	-	ns	V_{DD} =75 V, V_{GS} =10 V, I_{D} =42 A,
Turn-off delay time	$t_{\sf d(off)}$	-	26	-	ns	$R_{\rm G,ext}$ =1.6 Ω
Fall time	t_{f}	-	12	_	ns	

⁶⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 7)

Parameter	Symbol		Values			Note / Test condition
	Syllibol	Min.	Тур.	Max.		Note / Test condition
Gate to source charge ⁸⁾	Q_{gs}	-	27	36	nC	
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	17.3	-	nC	
Gate to drain charge ⁸⁾	Q_{gd}	-	15.7	24	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =42 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	$Q_{\rm sw}$	-	25	-	nC	
Gate charge total ⁸⁾	$Q_{ m g}$	-	69	86	nC	
Gate plateau voltage	$V_{ m plateau}$	-	5.4	-	V	
Gate charge total, sync. FET	$Q_{\rm g(sync)}$	-	58	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ⁸⁾	Q _{oss}	-	205	273	nC	V _{DS} =75 V, V _{GS} =0 V

 $^{^{7)} \;\;}$ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

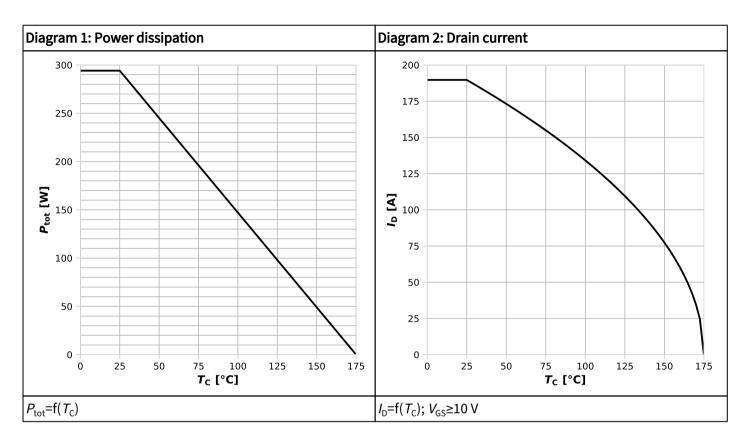
Parameter	Symbol	Values			Unit	Note / Test condition	
	Syllibol	Min.	Тур.	Max.		Note / Test condition	
Diode continuous forward current	I _S	-	-	190	А	<i>T_c</i> =25 °C	
Diode pulse current	I _{S,pulse}	-	-	760	Α	1 _C -25 C	
Diode forward voltage	$V_{\rm SD}$	-	0.87	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =84 A, $T_{\rm j}$ =25 °C	
Reverse recovery time ⁹⁾	t _{rr}	-	36	72	ns	V _R =75 V, I _F =42 A, d <i>i</i> _F /d <i>t</i> =500 A/μs	
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	156	312	nC		
Reverse recovery time ⁹⁾	t _{rr}	-	33	66	ns	1/-75 \	
Reverse recovery charge ⁹⁾	$Q_{\rm rr}$	-	277	554	nC	$V_{\rm R}$ =75 V, $I_{\rm F}$ =42 A, d $I_{\rm F}$ /d t =1000 A/ μ s	

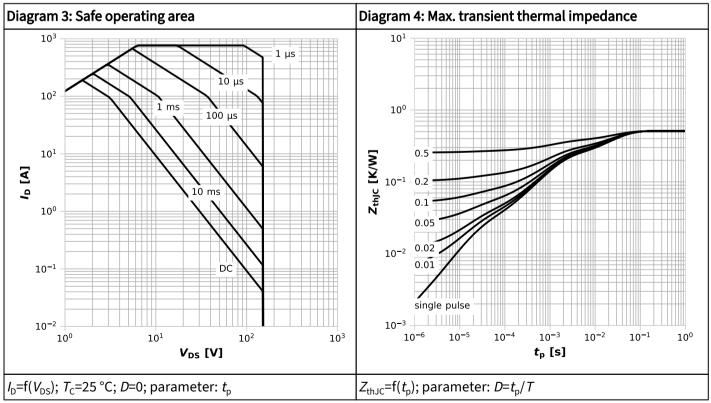
⁹⁾ Defined by design. Not subject to production test.

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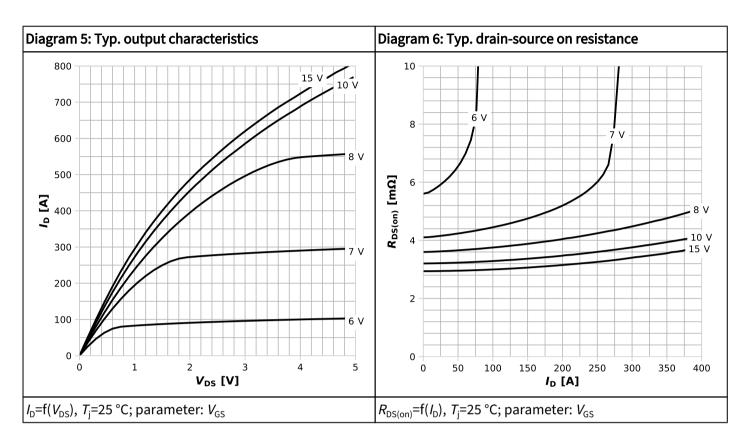


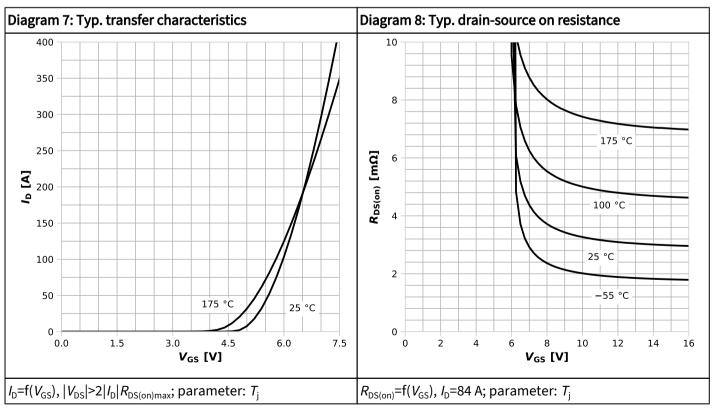
4 Electrical characteristics diagrams



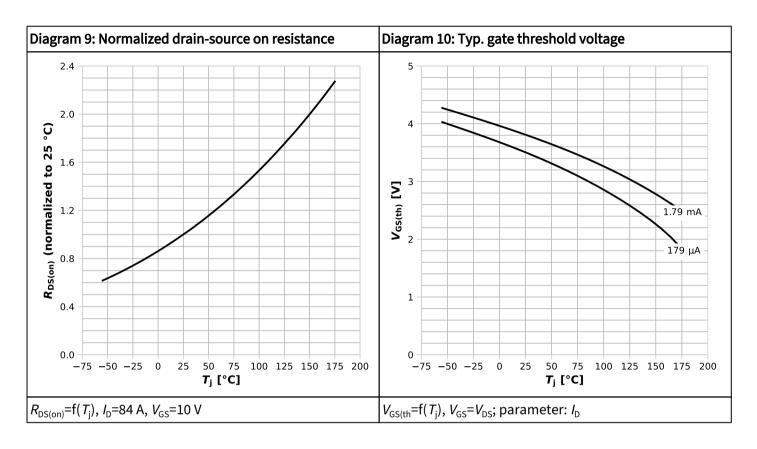


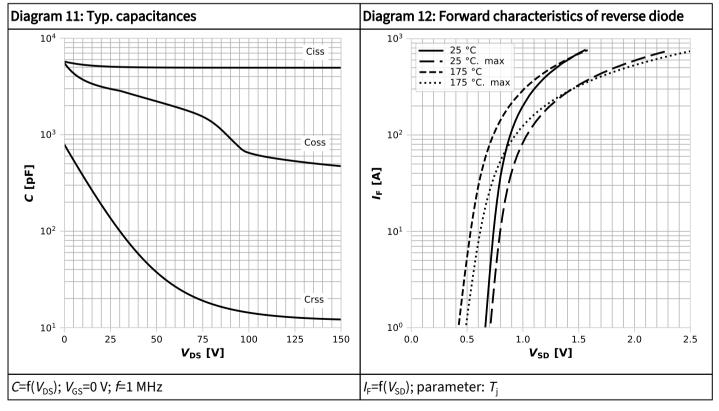




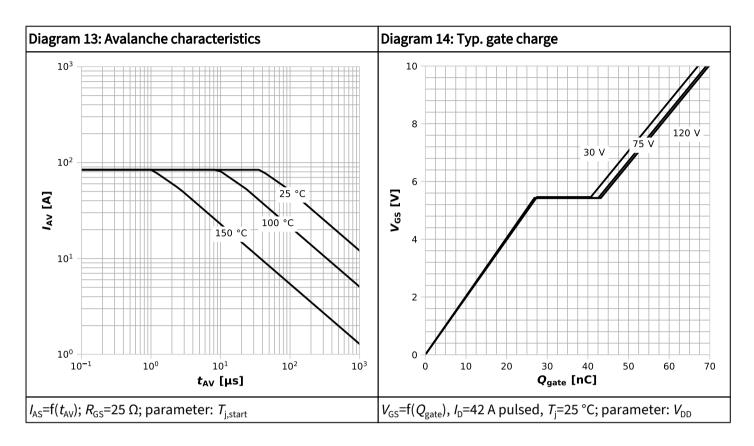


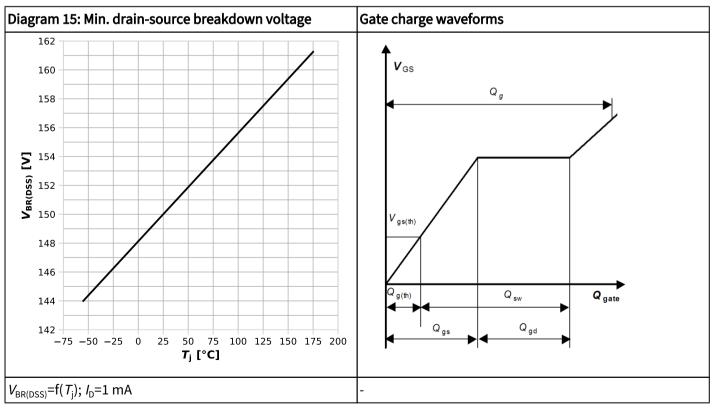














5 Package outlines

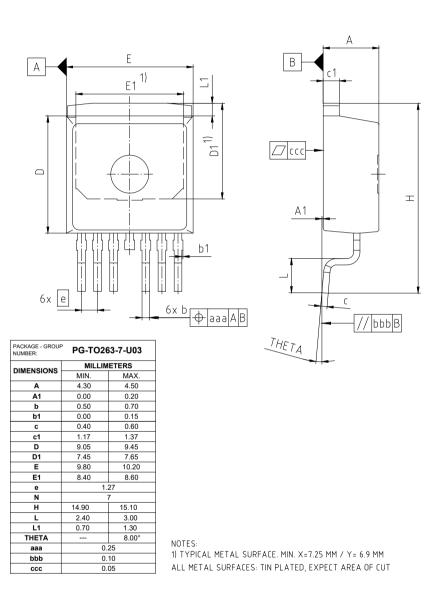


Figure 1 Outline PG-TO263-7, dimensions in mm



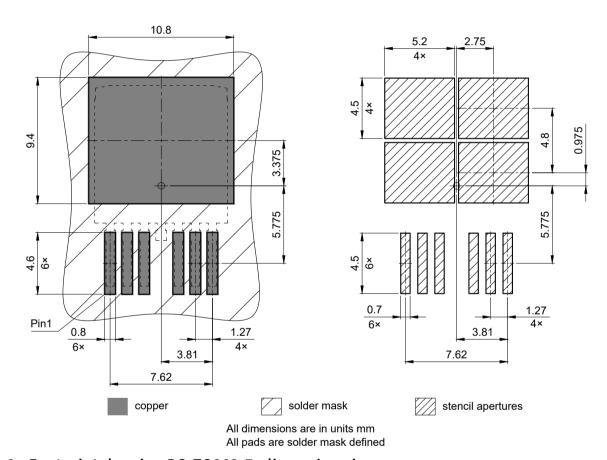


Figure 2 Footprint drawing PG-TO263-7, dimensions in mm

OptiMOS™ 6 Power-Transistor, 150 V IPF036N15NM6



Revision history

IPF036N15NM6

Revision 2024-12-09, Rev. 1.0

Previous revisions

Revision	rision Date Subjects (major changes since last revision)					
1.0	2024-12-09	Release of final datasheet				

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